The LMH5401EVM is an evaluation module for the single LMH5401 amplifier in a 14-lead high-performance RF package. This evaluation module is designed to quickly and easily demonstrate the functionality and versatility of the amplifier. The EVM is ready to connect to power, signal source, and test instruments through the use of onboard connectors. The EVM comes configured for easy connection with common 50-Ω laboratory equipment on its inputs and outputs. The amplifier is configured for single-ended input with gain of 12 dB (4 V/V). The board has differential outputs, one for each of the amplifier outputs. It can be easily configured for differential inputs, and single- or split-supply operation.

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Features

1 Features

- Configured for split-supply operation and easily modified for single supply
- Single ended or differential input signals
- Fully differential output
- Designed for easy connection to standard 50-Ω input/output impedance test equipment
- Inputs and outputs include SMA connectors

Figure 1. LMH5401EVM Board

2 EVM Specifications

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>VALUE</th>
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</thead>
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<tr>
<td>$V_{S}$</td>
<td>Single-supply voltage range ($V_– = ground$)</td>
</tr>
<tr>
<td>$V_{S±}$</td>
<td>Split-supply voltage range</td>
</tr>
<tr>
<td>GND</td>
<td>Ground reference pins</td>
</tr>
<tr>
<td>PD</td>
<td>Power down (PD) input voltage</td>
</tr>
<tr>
<td>$I_{S±}$</td>
<td>Supply current</td>
</tr>
<tr>
<td>$I_{IN}$</td>
<td>Input voltage</td>
</tr>
<tr>
<td>$I_{OUT}$</td>
<td>Output drive</td>
</tr>
</tbody>
</table>
3 Power Connections

The LMH5401EVM is equipped with test loops for easy connection of power. The positive supply input is red and is labeled V+. The negative supply input is yellow and is labeled V–. Ground is black and is labeled GND.

3.1 Split-Supply Operation

To operate as split supply, apply the positive supply voltage to V+, negative supply voltage to V–, and the ground reference from supply to GND. The supply voltages do not need to be symmetrical, provided that the total supply voltage is between 3.15 V and 5.25 V, any combination of positive and negative supply voltages is acceptable. This feature is often used when the output common mode voltage must be set to a particular value. For best performance, the power supply voltages should be symmetrical around the desired output common-mode voltage.

3.2 Single-Supply Operation

To operate as single supply, connect jumper V– to GND, and apply the positive supply voltage to V+. Inputs and outputs must be biased as in the LMH5401 datasheet (SBO5710) specifications for proper operation.

4 Input and Output Connections

The LMH5401EVM is equipped with SMA connectors for easy connection of signal generators and analysis equipment. As shipped, the EVM is configured for a gain of 12 dB, split supply, single-ended input and differential outputs each with 50-Ω termination. For best results, signals must be routed to and from the EVM with cables having 50-Ω characteristic impedance. The input connectors for single-ended input signals are IN+ and IN– which are symmetrical. The output connectors are OUT+ and OUT–. In addition to the signal cables a 50-Ω resistive termination is required for the unused input. See the LMH5401 datasheet for additional detail on configuring the device.

4.1 CM (Output Common Mode Voltage) Input

The LMH5401 device has an output common-mode control pin that sets the output common mode voltage. The evaluation board is configured with a resistive divider to set the output common mode voltage at the mid supply voltage. If a different output common-mode voltage is specified, the SMA connector can be used to connect an external voltage source. The valid voltage range for the CM pin is approximately (\([V+] – 2 \text{ V}\)) to (\([V–] + 2 \text{ V}\)). See the LMH5401 datasheet for performance curves that show how performance is impacted by an output common mode voltage that is not at the mid-supply voltage.

4.2 PD (Power Down) Input

The LMH5401 device has a power-down input pin that allows the amplifier to enter a low-power state when it does not need to be active. The LMH5401 PD pin is referenced to the GND pin. The threshold voltage is 1.1 V. Any voltage over 1.2 V above the ground reference pins will disable the amplifier. Any input below 0.9 V enables the amplifier. Because the PD pin is not referenced to either of the supply pins the same logic level can be used for the PD function regardless of the configuration of the supply voltages. The LMH5401EVM has a jumper (JPD) that allows the amplifier to be manually disabled. In order to facilitate driving the PD pin with a high-speed signal source, the resistor-capacitor combination (Rsd/C9) provides high frequency termination for signals from a 50-Ω pulse generator.

4.3 Single-Ended Inputs

The LMH5401 device was designed for use with 50-Ω single-ended inputs. Even though the board was designed for single-ended inputs, the board is fully symmetrical, so either input can be used. Connect a 50-Ω signal source to either IN+ or IN– and connect a 50-Ω SMA termination to the other input. This way both inputs have the same termination condition and the circuit is balanced. In the case where no SMA 50-Ω termination is available, soldering a 50-Ω resistor from the unused input signal trace to the ground plane is acceptable. A small section of the ground plane has no solder mask that can be used for this purpose.
4.4 Differential Inputs

Using the LMH5401 for differential inputs is possible, however the on chip resistors will need to be changed first. The LMH5401 device has an internal resistance of 25 Ω between the output and the FB connections. Once the desired value of the Rf resistors is determined reduce them by 25 Ohms. To impedance match a 100-Ω differential source, the R1- and R2 resistors both need to be 50 Ω. The desired gain will then determine the required value for Rf+ and Rf-. The gain will be $Av = \frac{(Rf + 25)}{Rg}$. As with other RF devices the final, system gain will depend on the source resistance and the load resistance.

4.5 Differential Outputs

The LMH5401EVM has two output SMA connectors that are designed to mate to 50-Ω test equipment. By connecting both outputs to 50-Ω test equipment, the output load is 100-Ω differential. With the on chip and on board matching resistors, the total load to the amplifier is 200 Ω. The matching resistors cause a 6-dB loss in voltage gain. The evaluation board has 40-Ω resistors on the board because there are 10-Ω output resistors on chip inside the device.

4.6 Single-Ended Outputs

Using an external balun to combine the two differential outputs creates a single-ended signal that can be interfaced to most 50-Ω test equipment. This is the method used by TI engineers to create the datasheet plots. To match the performance of the LMH5401 device, a very broadband balun must be selected. TI recommends the Marki B0100 or the PicoPulse Labs 5310A baluns.
5 LMH5401EVM Schematic, Layout, and Bill of Materials

This section contains the EVM schematic, PCB layouts, and the bill of materials (BOM).

5.1 Schematic

Figure 2 illustrates the LMH5401EVM schematic.
5.2 LMH5401EVM Layers

Figure 3 through Figure 8 show the LMH5401EVM layers.

Figure 3. LMH5401EVM Top Layer

Figure 4. Layer 2
Figure 5. Layer 3

Figure 6. Layer 4
Figure 7. Layer 5

Figure 8. Bottom Layer
### 5.3 Bill of Materials

Table 1 lists the EVM BOM.

<table>
<thead>
<tr>
<th>Item</th>
<th>Designator</th>
<th>Value</th>
<th>Description</th>
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## Revision History

### Changes from Original (October 2014) to A Revision

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<tr>
<td>Corrected <em>Value</em> column in Table 1: moved all entries down by one row</td>
<td>9</td>
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**NOTE:** Page numbers for previous revisions may differ from page numbers in the current version.
1. **Delivery:** TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, or documentation (collectively, an “EVM” or “EVMs”) to the User (“User”) in accordance with the terms and conditions set forth herein. Acceptance of the EVM is expressly subject to the following terms and conditions.

   1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM (“Software”) shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms and conditions that accompany such Software.

   1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.

2. **Limited Warranty and Related Remedies/Disclaimers:**

   2.1 These terms and conditions do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.

   2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for any defects that are caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI. Moreover, TI shall not be liable for any defects that result from User's design, specifications or instructions for such EVMs. Testing and other quality control techniques are used to the extent TI deems necessary or as mandated by government requirements. TI does not test all parameters of each EVM.

   2.3 If any EVM fails to conform to the warranty set forth above, TI's sole liability shall be at its option to repair or replace such EVM, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

3. **Regulatory Notices:**

   3.1 United States

   3.1.1 Notice applicable to EVMs not FCC-Approved:

   This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

   3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

   **CAUTION**

   This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

   Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

   **FCC Interference Statement for Class A EVM devices**

   **NOTE:** This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.
FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada
3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

3.3 Japan
3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lds/ti/ ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
http://www.tij.co.jp/lds/ti_ ja/general/eStore/notice_01.page

3.3.2 Notice for Users of EVMs Considered “Radio Frequency Products” in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry’s Rule for Enforcement of Radio Law of Japan.

2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or

3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.
【無線電波を送信する製品の開発キットをお使いになる際の注意事項】開発キットの中には技術基準適合証明を受けていないものがあります。技術基準適合証明を受けていないものご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

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日本テキサス・インスツルメンツ株式会社
東京都新宿区西新宿6丁目24番1号
西新宿三井ビル

3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page

電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page

4 EVM Use Restrictions and Warnings:

4.1 EVMs ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.

4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.

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